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T:25-15

查询BTA08A-200A供应商

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, 24小时加急出货

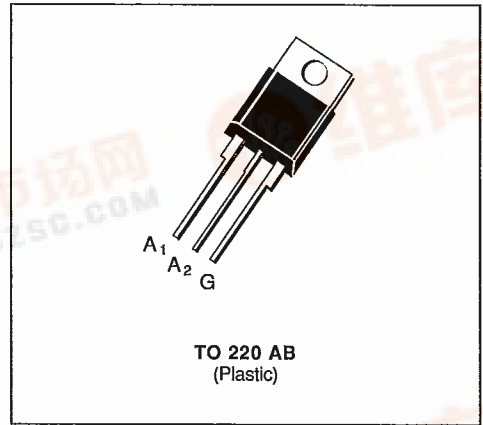
SGS-THOMSON
MICROELECTRONICS

BTA/BTB 08 A

SGS-THOMSON

SENSITIVE GATE TRIACS

- GLASS PASSIVATED CHIP
- I_{GT} SPECIFIED IN FOUR QUADRANTS
- AVAILABLE IN INSULATED VERSION → BTA SERIES (INSULATING VOLTAGE 2500 V_{RMS}) OR IN UNINSULATED VERSION → BTB SERIES
- UL RECOGNIZED FOR BTA SERIES (E81734)



DESCRIPTION

New range suited for applications such as phase control and static switching.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state Current (360° conduction angle)	$T_C = 75\text{ °C}$ 8	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C - Half sine wave)	$t = 8.3\text{ ms}$	84
		$t = 10\text{ ms}$	80
I^2t	I^2t Value for Fusing	$t = 10\text{ ms}$ 32	A ² s
di/dt	Critical Rate of Rise of on-state Current (1)	Repetitive F = 50 Hz	10
		Non Repetitive	50
T_{stg} T_j	Storage and Operating Junction Temperature Range	- 40 to 150	°C
		- 40 to 110	°C

Symbol	Parameter	BTA/BTB 08-					Unit
		200A	400A	600A	700A	800A	
V_{DRM}	Repetitive Peak off-state Voltage (2)	200	400	600	700	800	V

(1) $I_G = 250\text{ mA}$ $di/dt = 1\text{ A}/\mu\text{s}$

(2) $T_j = 110\text{ °C}$

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to Ambient	60	°C/W
$R_{th(j-c)}\text{ DC}$	Junction to Case for DC	5.1	°C/W
$R_{th(j-c)}\text{ AC}$	Junction to Case for 360° Conduction Angle (F = 50 Hz)	3.8	°C/W

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GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40 \text{ W}$ ($t_p = 10 \mu\text{s}$) $I_{GM} = 4 \text{ A}$ ($t_p = 10 \mu\text{s}$)
 $P_{G(AV)} = 1 \text{ W}$ $V_{GM} = 16 \text{ V}$ ($t_p = 10 \mu\text{s}$)

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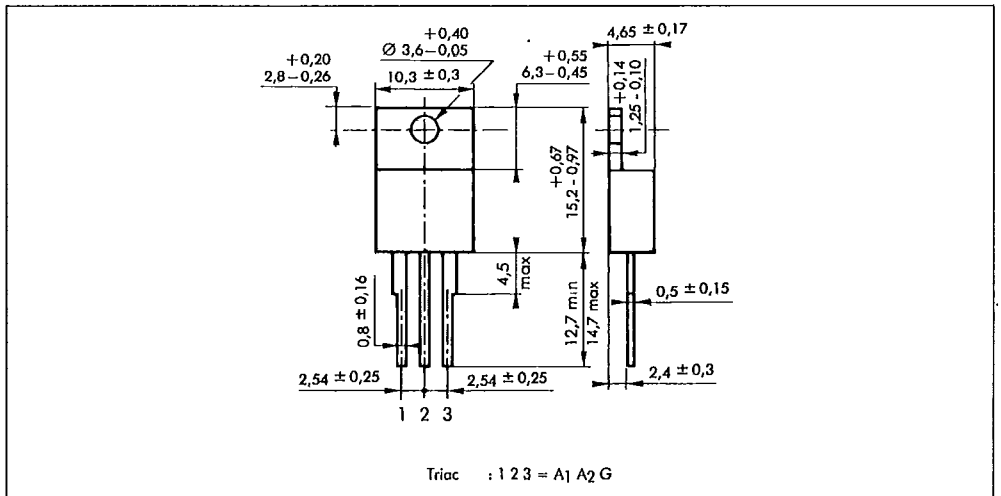
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$	I-II-III			10	mA
				IV			25	
V_{GT}	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$	I-II-III-IV			1.5	V
V_{GD}	$T_j = 110 \text{ }^\circ\text{C}$	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	I-II-III-IV	0.2			V
I_H^*	$T_j = 25 \text{ }^\circ\text{C}$	$I_T = 100 \text{ mA}$	Gate Open				25	mA
I_L	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs	$V_D = 12 \text{ V}$	$I_G = 50 \text{ mA}$	I-III-IV		25		mA
				II		50		
V_{TM}^*	$T_j = 25 \text{ }^\circ\text{C}$	$I_{TM} = 11 \text{ A}$	$t_p = 10 \text{ ms}$				1.75	V
I_{DRM}^*	V_{DRM} Specified						0.01	mA
							0.5	
dv/dt^*	$T_j = 110 \text{ }^\circ\text{C}$	Gate Open			10			V/ μs
	Linear Slope up to $V_D = 67 \% V_{DRM}$							
$(dv/dt)_c^*$	$T_C = 75 \text{ }^\circ\text{C}$	$V_D = V_{DRM}$	$I_T = 11 \text{ A}$			5		V/ μs
	$(di/dt)_c = 3.5 \text{ A/ms}$							
t_{gt}	$T_j = 25 \text{ }^\circ\text{C}$	$V_D = V_{DRM}$	$I_T = 11 \text{ A}$	I-II-III-IV		2		μs
	$I_G = 40 \text{ mA}$ $di_G/dt = 0.45 \text{ A}/\mu\text{s}$							

* For either polarity of electrode A_2 voltage with reference to electrode A_1 .

PACKAGE MECHANICAL DATA

TO 220 AB Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g

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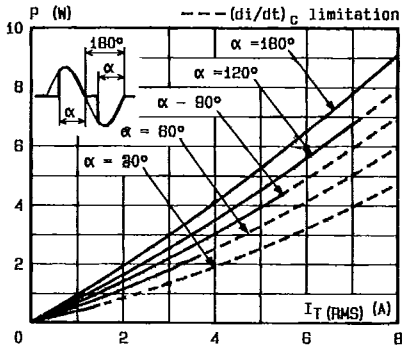


Fig. 1 - Maximum mean power dissipation versus RMS on-state current ($F = 60$ Hz).

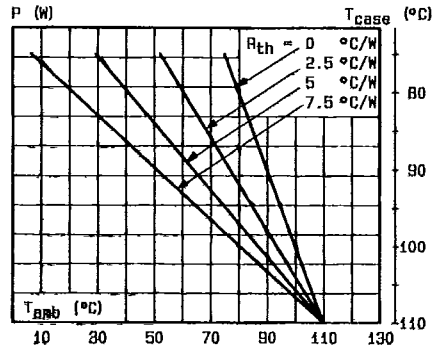


Fig. 2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatlink + contact.

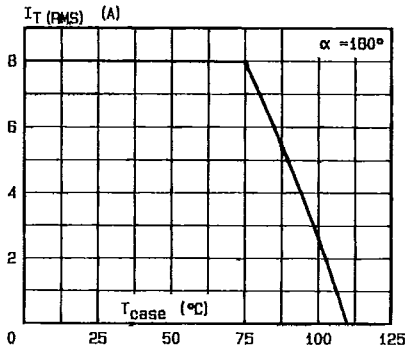


Fig. 3 - RMS on-state current versus case temperature.

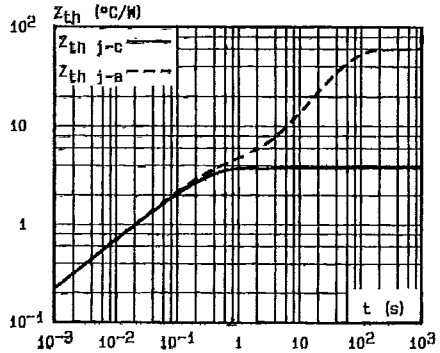


Fig. 4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

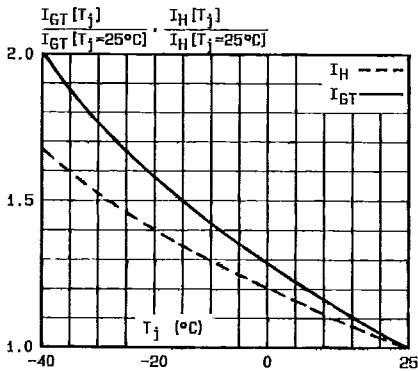


Fig. 5 - Relative variation of gate trigger current and holding current versus junction temperature.

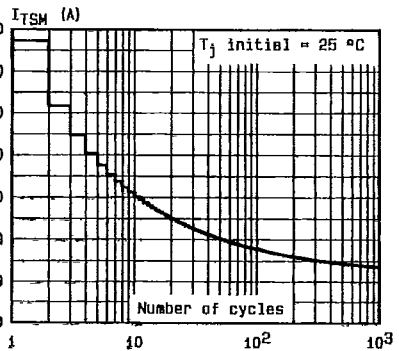


Fig. 6 - Non repetitive surge peak on-state current versus number of cycles.

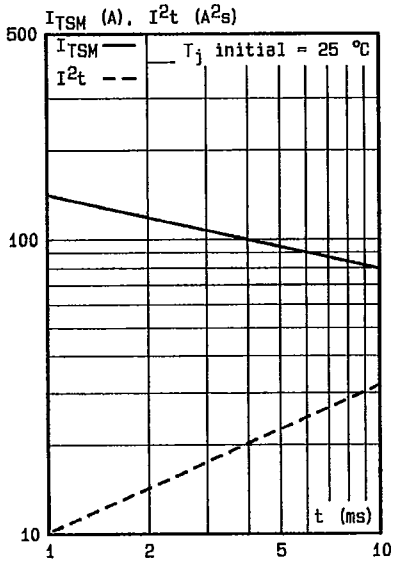


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

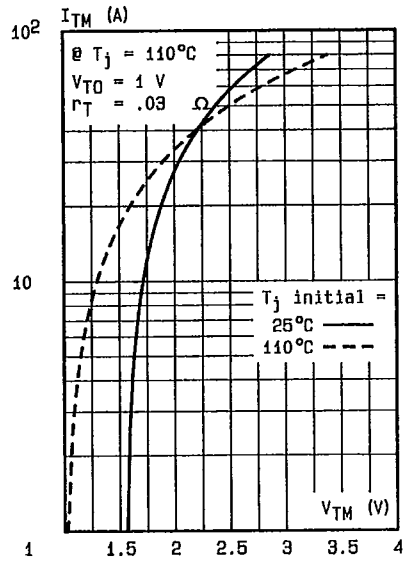


Fig.8 - On-state characteristics (maximum values).